

Features:

- MEMS Technology
- Direct pin to pin drop-in replacement for industry-standard packages
- LVC MOS/HCMOS Compatible Output
- Industry-standard package 2.0 x 1.6, 2.5 x 2.0, 3.2 x 2.5, and 5.0 x 3.2 mm x mm
- Pb-free, RoHS and REACH compliant
- Fast delivery times

Typical Applications:

- Fibre Channel
- Server and Storage
- GPON, EPON
- 100M / 1G /10G Ethernet

Electronic Specifications:

Frequency Range	115.194001 MHz to 137.000MHz	
Frequency Stability	See Part Number Guide	Inclusive of Initial Tolerance, Operating Temperature Range, Load, Voltage, and Aging
Operating Temperature	See Part Number Guide	
Supply Voltage (Vdd) ±10%	See Part Number Guide	
Current Consumption	6.2 mA typ./ 8.0 mA max 5.4 mA typ./ 7.0 mA max 4.9 mA typ./ 6.0 mA max	No load condition, F = 125 MHz, Vdd = +2.8 V, +3.0 V or +3.3 V No load condition, F = 125 MHz, Vdd = +2.5 V No load condition, F = 125 MHz, Vdd = +1.8 V
OE Disable Current	4.7 mA max 4.5 mA max	Vdd = +2.5 V, or +3.3 V, OE = Low, output is high Z state Vdd = +1.8 V, OE = Low, output is high Z state
Standby Current	2.6 µA typ./ 8.5 µA max 1.4 µA typ./ 5.5 µA max 0.6 µA typ./ 4.0 µA max	Vdd = +2.8 V to 3.3 V, $\overline{ST}$ = low Vdd = +2.5 V, $\overline{ST}$ = Low Vdd = +1.8 V, $\overline{ST}$ = Low
Waveform Output	LVC MOS/HCMOS	
Symmetry	45%/55%	50% of waveform
Rise / Fall Time	1.0 nSec typ./ 2.0 nSec max 1.3 nSec typ./ 2.5 nSec max	Vdd = +2.5 V, +2.8 V, 3.0 V or 3.3 V from 20% to 80% of waveform Vdd = +1.8 V, from 20% to 80% of waveform
Logic "1"	90% of Vdd min	
Logic "0"	10% of Vdd max	
Input Voltage High	70% of Vdd min	Pin 1, OE or $\overline{ST}$
Input Voltage Low	30% of Vdd max	Pin 1, OE or $\overline{ST}$
Input Pull-up Impedance	50 kΩ min / 87 kΩ typ./ 150 kΩ max 2.0 MΩ min	Pin 1, OE logic high or logic low, or $\overline{ST}$ logic high Pin 1, $\overline{ST}$ logic low
Startup Time	5 mSec max	Measured from the time Vdd reaches its rated minimum values
Enable/Disable Time	130 nSec max	F = 115.194001 MHz, For other frequencies, T _{oe} = 100 nSec + 3 * clock periods
Resume Time	5 mSec max	Measured from the time $\overline{ST}$ pin crosses 50% threshold.
RMS Period Time	1.6 pSec typ./ 2.5 pSec max 1.8 pSec typ./ 3.0 pSec max	F = 125 MHz, Vdd = +2.5 V, +2.8 V, +3.0 V or +3.3 V F = 125 MHz, Vdd = +1.8 V
Peak-to-Peak Period Jitter	12 pSec typ./ 20 pSec max 14 pSec typ./ 30 pSec max,	F = 125 MHz, Vdd = +2.5 V, +2.8 V, +3.0 V or +3.3 V F = 125 MHz, Vdd = +1.8 V
RMS Period Time (random)	0.5 pSec typ./ 0.8 pSec max, 1.3 pSec typ./ 2.0 pSec max,	F = 125 MHz, Integration bandwidth = 900 kHz to 7.5 MHz F = 125 MHz, Integration bandwidth = 12.0 kHz to 20.0 MHz

Notes:

- All min and max limits are specified over temperature and rated operating voltage with 15pF output unless otherwise stated.
- Typical values are at +25°C and nominal supply voltage.

Ordering Information:

Part Number Guide						
Packages	Input Voltage	Operating Temperature	Output Drive Strength	Stability (ppm)	Select Function	Frequency
IM821B – 5.0 x 3.2 IM821C – 3.2 x 2.5 IM821D – 2.5 x 2.0 IM821E – 2.0 x 1.6	1 = +1.8 V 6 = +2.5 V 2 = +2.8 V 7 = +3.0 V 3 = +3.3 V .	E = -40°C to +105°C F = -40°C to +125°C	- = Default (see tables 2 through 6)	F = ±20 A = ±25 Z = ±30 B = ±50	H = Tri-State S = Standby O = N/C	- Frequency

Sample Part Number: **IM821C-6E-FS-100.0000 MHz**

This 100.0000 MHz oscillator in a 3.2 x 2.5 package with stability ±20 ppm from -40°C to +105°C using a supply voltage of +2.5 V. The Output Drive Strength (Rise and Fall Time) is 0.96 nSec per Table 2 with 15 pF load. With Pin 1 function as Standby

Sample Part Number: **IM821B-1FEAH-125.0000 MHz**

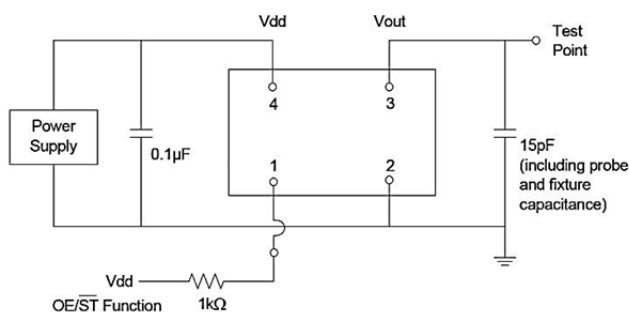
This 125.0000 MHz oscillator in a 5.0 x 3.2 package with stability ±25 ppm from -40°C to +125°C using a supply voltage of +1.8 V. The Output Drive Strength (Rise and Fall Time) is 0.78 nSec per Table 1 with 5 pF load. With Pin 1 function as Tri-state

Notes:

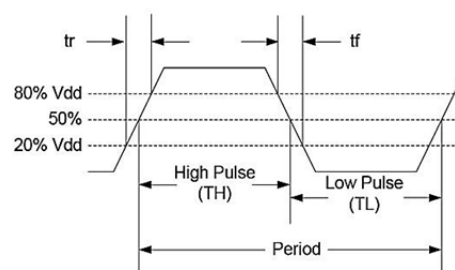
- Not all options are available at all frequencies and temperatures ranges.
- Please consult with sales department for any other parameters or options.
- Oscillator specification subject to change without notice.

Absolute Maximum Limits	
Storage Temperature	-65°C to +150°C
Supply Voltage (Vdd)	-0.5 VDC to 4.0 VDC
Electrostatic Discharge	2000 V max
Solder Temperature (follow standard Pb free soldering guidelines)	260°C max
Junction Temperature	150°C max

Test Circuit



Waveform



Performance Plots:

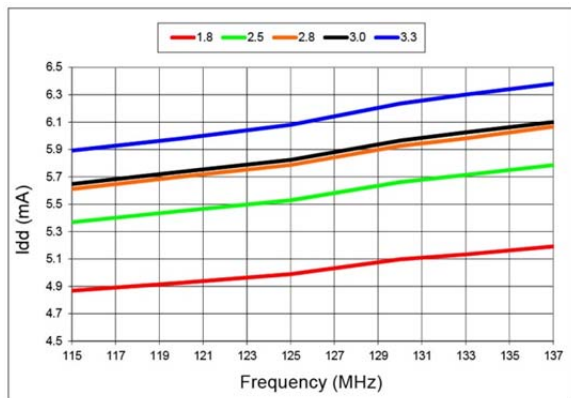


Figure 1: Idd vs Frequency

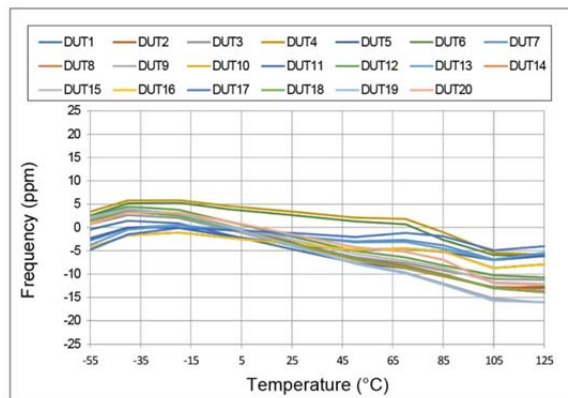


Figure 2: Frequency vs Temperature

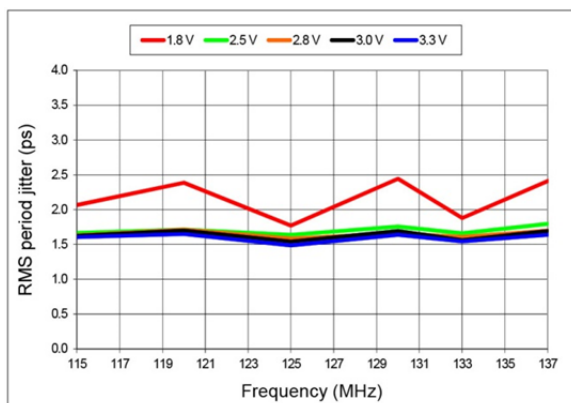


Figure 3: RMS Period Jitter vs Frequency

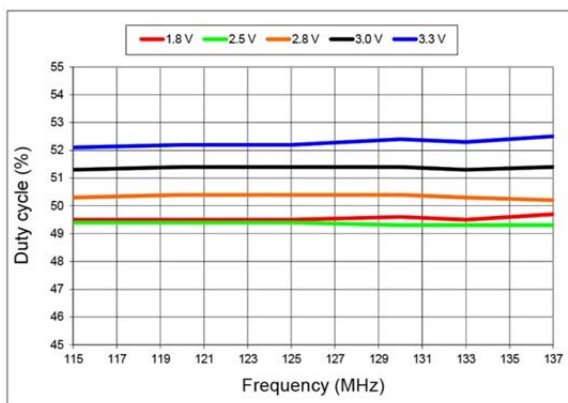


Figure 4: Duty Cycle vs Frequency

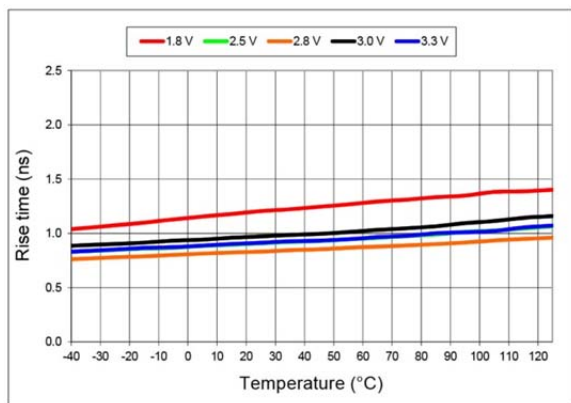


Figure 5: 20% to 80% Rise Time vs Temperature

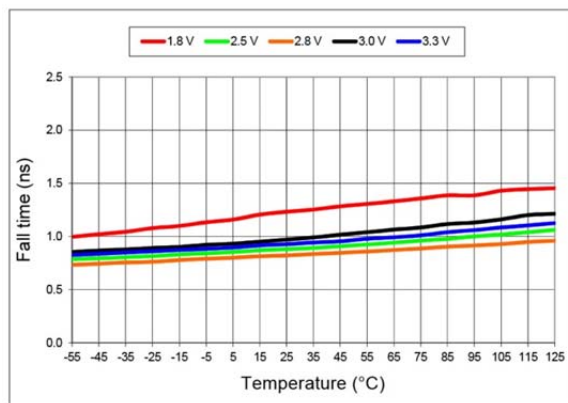


Figure 6: 20% to 80% Fall Time vs Temperature

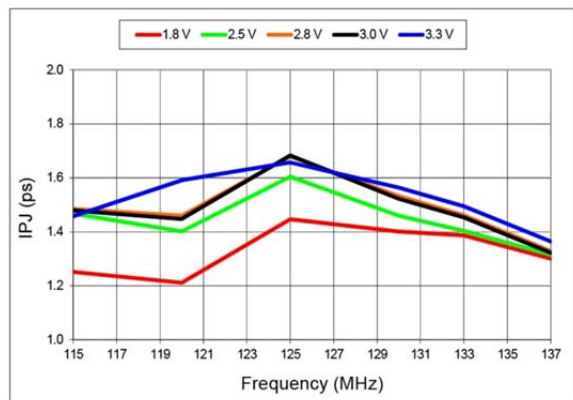


Figure 7: RMS Integrated Phase Jitter Random (12 kHz to 20.0 MHz) vs Frequency

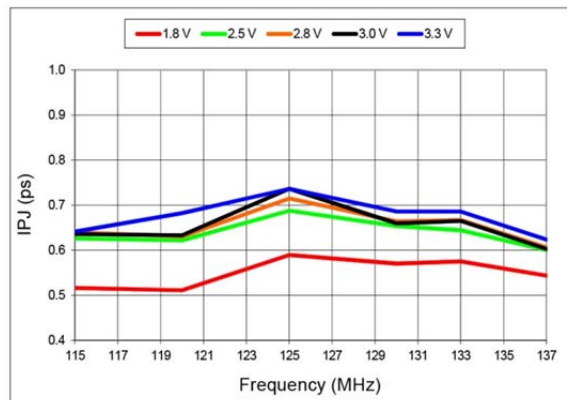
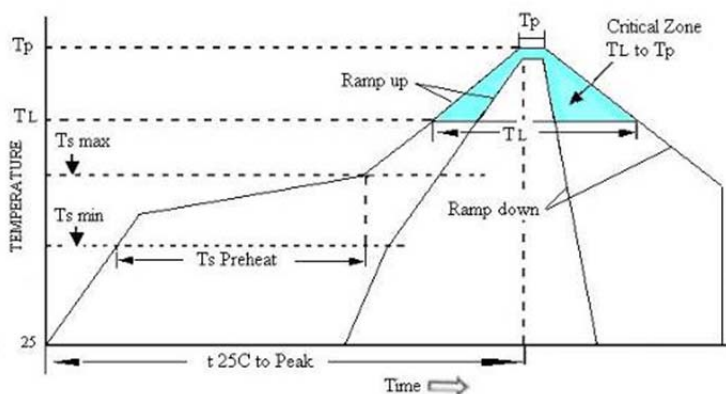


Figure 8: RMS Integrated Phase Jitter Random (900 kHz to 20.0 MHz) vs Frequency

Environmental Specifications:

Environmental Compliance	
Parameter	Condition/Test Method
Mechanical Shock	MIL-STD-883F, Method 2002
Mechanical Vibration	MIL-STD-883F, Method 2007
Temperature Cycle	JESD22, Method A104
Solderability	MIL-STD-883F, Method 2003
Moisture Sensitivity Level	MSL Level 1 at +260°C

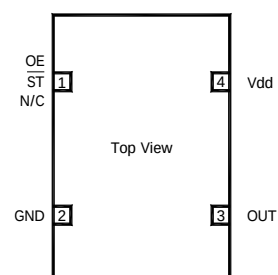
Pb Free Solder Reflow Profile



Units are backward compatible with +240°C reflow processes

Ts max to TL (Ramp-up Rate)	3°C / second max
Preheat	
Temperature min (Ts min)	150°C
Temperature typ (Ts typ)	175°C
Temperature max (Ts max)	200°C
Time (Ts)	60 to 180 seconds
Ramp-up Rate (TL to Tp)	3°C / second max
Time Maintained Above Temperature (TL)	217°C
Time (TL)	60 to 150 seconds
Peak Temperature (Tp)	260°C max for seconds
Time within 5°C to Peak Temperature (Tp)	20 to 40 seconds
Ramp-down Rate	6°C / second max
Time 25°C to Peak Temperature	8 minute max
Moisture Sensitivity Level (MSL)	Level 1

Pin Functionally

Pin Description				Pin Assignments
Pin	Symbol	Functionality		
1	OE	Tri-state	High or Open = specified frequency output Low = Output is high impedance, only output is disabled.	 <p>Top View</p>
	$\overline{ST}$	Standby	High or Open = specified frequency output. Low = Output is low. Device goes to sleep mode. Supply current reduces to standby current.	
	N/C	No Connect	Any voltage between 0.0 V to Vdd or Open = specified frequency output Pin 1 has no function	
2	GND	Power	Electrical ground	
3	Out	Output	Oscillator output	
4	Vdd	Power	Power supply voltage	
Notes: 1. In OE or $\overline{ST}$ mode, a pull-up resistor of 10.0 k Ω or less is recommended if Pin 1 is not externally driven. If Pin 1 needs to be left floating, use the NC option. 2. A capacitor of value 0.1 μ F or higher between Pin 4 (Vdd) and Pin 1 (GND) is required.				

Pin 1 Configuration Options (OE, or $\overline{ST}$, or NC)

Pin 1 of the IM821 can be factory-programmed to support three modes: Output Enable (OE), Standby ($\overline{ST}$) or No Connect (NC).

Output Enable (OE) Mode

In the OE mode, applying logic Low to the OE pin only disables the output driver and puts it in Hi-Z mode. The core of the device continues to operate normally. Power consumption is reduced due to the inactivity of the output. When the OE pin is pulled High, the output is typically enabled in <1 μ Sec.

Standby $\overline{ST}$ Mode

In the ST mode, a device enters into the standby mode when Pin 1 pulled Low. All internal circuits of the device are turned off. The current is reduced to a standby current, typically in the range of a few μ A. When $\overline{ST}$ is pulled High, the device goes through the "resume" process, which can take up to 5 mSec.

No Connect (NC) Mode

In the NC mode, the device always operates in its normal mode and outputs the specified frequency regardless of the logic level on Pin 1.

Table 1 below summarizes the key relevant parameters in the operation of the device in OE, ST, or NC mode.

Parameters	OE	ST	NC
Active current 20.0 MHz (max +1.80 VDC)	6.0 mA	6.0 mA	6.0 mA
OE disable current (max +1.80 VDC)	4.5 mA	N/A	N/A
Standby current (typical +1.80 VDC)	N/A	0.6 μ A	N/A
OE enable time at 20.0 MHz (max)	200 nSec	N/A	N/A
Resume time from standby (max, all frequency)	N/A	5 mSec	N/A
Output driver in OE disable/standby mode	High Z		N/A

Table 1 OE vs. $\overline{ST}$ vs. NC

Timing Diagrams:

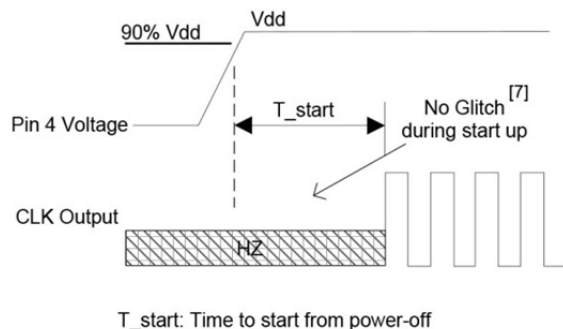


Figure 9: Startup Timing (OE/ST Mode)

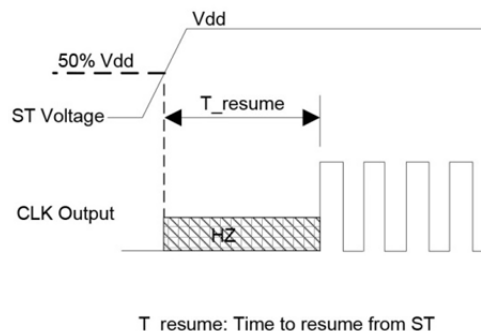


Figure 10: Standby Resume Timing (ST Mode Only)

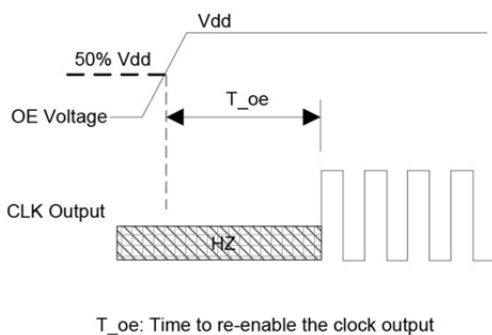


Figure 11: OE Enable Timing (OE Mode Only)

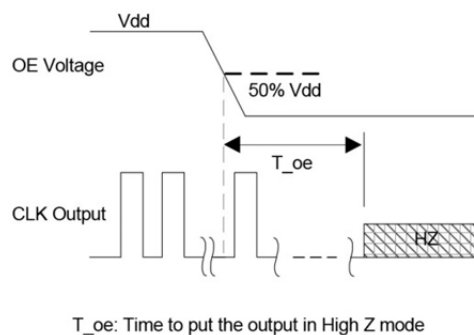


Figure 10: OE Disable Timing (OE Mode Only)

Selectable Drive Strength Option
Rise/Fall Time (20 % to 80 %) vs C_{LOAD} Tables

Rise/Fall Time Typ (nS)			
Drive Strength (C _{LOAD})	5 pF	15 pF	30 pF
T	0.93	N/A	N/A
E	0.78	N/A	N/A
U	0.70	1.48	N/A
- = Default	0.65	1.30	N/A

Rise/Fall Time Typ (nS)			
Drive Strength (C _{LOAD})	5 pF	15 pF	30 pF
R	1.45	N/A	N/A
B	1.09	N/A	N/A
T	0.62	1.28	N/A
E	0.54	1.00	N/A
- = Default	0.43	0.96	N/A
F	0.34	0.88	N/A

Table 2: V_{dd} = +1.8 V Rise/Fall time for Specific C_{LOAD}

Table 3: V_{dd} = +2.5 V Rise/Fall time for Specific C_{LOAD}

Rise/Fall Time Typ (nS)			
Drive Strength (C _{LOAD})	5 pF	15 pF	30 pF
R	1.29	N/A	N/A
B	0.97	N/A	N/A
T	0.55	1.12	N/A
U	0.44	1.00	N/A
- = Default	0.34	0.88	N/A
F	0.29	0.81	1.48

Rise/Fall Time Typ (nS)			
Drive Strength (C _{LOAD})	5 pF	15 pF	30 pF
R	1.22	N/A	N/A
B	0.89	N/A	N/A
- = Default	0.51	1.00	N/A
E	0.38	0.92	N/A
U	0.30	0.83	N/A
F	0.27	0.76	1.39

Table 4: V_{dd} = +2.8 V Rise/Fall time for Specific C_{LOAD}

Table 5: V_{dd} = +3.0 V Rise/Fall time for Specific C_{LOAD}

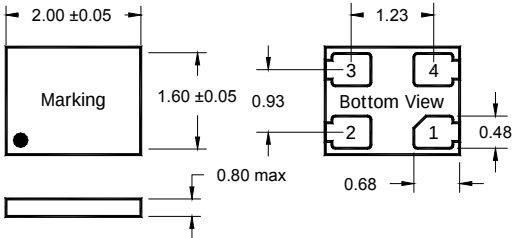
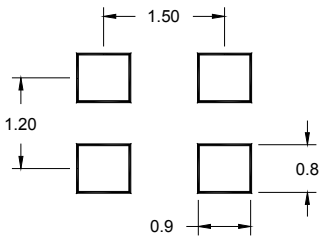
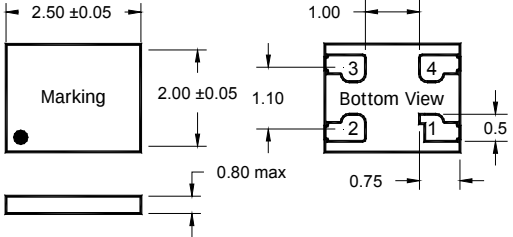
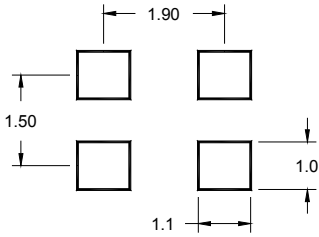
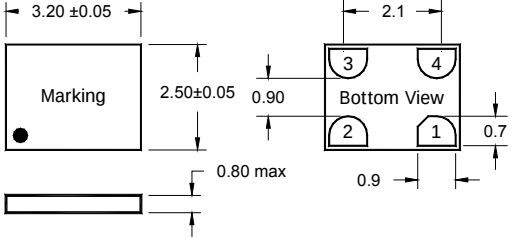
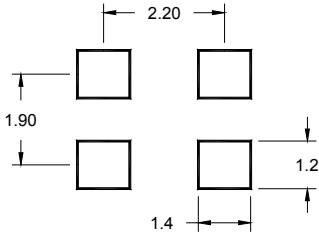
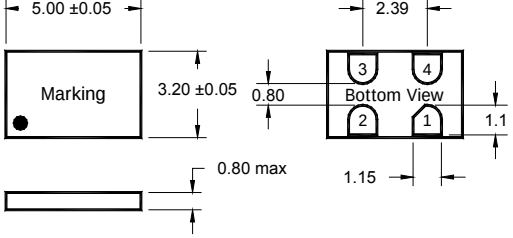
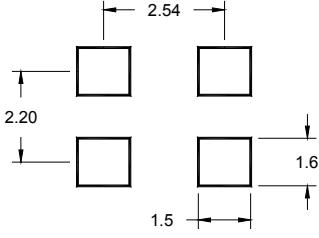
Rise/Fall Time Typ (nS)			
Drive Strength (C _{LOAD})	5 pF	15 pF	30 pF
R	1.16	N/A	N/A
B	0.81	N/A	N/A
- = Default	0.46	1.00	N/A
E	0.33	0.87	N/A
U	0.28	0.79	1.46
F	0.25	0.72	1.31

Table 6: V_{dd} = +3.3 V Rise/Fall time for Specific C_{LOAD}

Note:

- "n/a" in Table 2 to Table 6 indicates that the resulting Rise/Fall time from the respective combination of the drive strength and output load does not provide rail-to-rail swing is not available.

Mechanical Details:

<p>Option E: 2.00 x 1.60 x 0.80 Package</p>  <p>Top View: 2.00 ±0.05, 1.60 ±0.05, 0.93, 0.80 max, Marking</p> <p>Bottom View: 1.23, 0.68, 0.48, 0.93</p>	<p>Suggested Land Pattern</p>  <p>Dimensions: 1.50, 1.20, 0.9, 0.8</p>
<p>Option D: 2.50 x 2.00 x 0.80 Package</p>  <p>Top View: 2.50 ±0.05, 2.00 ±0.05, 1.10, 0.80 max, Marking</p> <p>Bottom View: 1.00, 0.75, 0.5, 1.10</p>	<p>Suggested Land Pattern</p>  <p>Dimensions: 1.90, 1.50, 1.1, 1.0</p>
<p>Option C: 3.20 x 2.50 x 0.80 Package</p>  <p>Top View: 3.20 ±0.05, 2.50 ±0.05, 0.90, 0.80 max, Marking</p> <p>Bottom View: 2.1, 0.9, 0.7, 0.90</p>	<p>Suggested Land Pattern</p>  <p>Dimensions: 2.20, 1.90, 1.4, 1.2</p>
<p>Option B: 5.00 x 3.20 x 0.80 Package</p>  <p>Top View: 5.00 ±0.05, 3.20 ±0.05, 0.80, 0.80 max, Marking</p> <p>Bottom View: 2.39, 1.15, 1.1, 0.80</p>	<p>Suggested Land Pattern</p>  <p>Dimensions: 2.54, 2.20, 1.5, 1.6</p>

Package Dimensions and Suggest Land Pattern

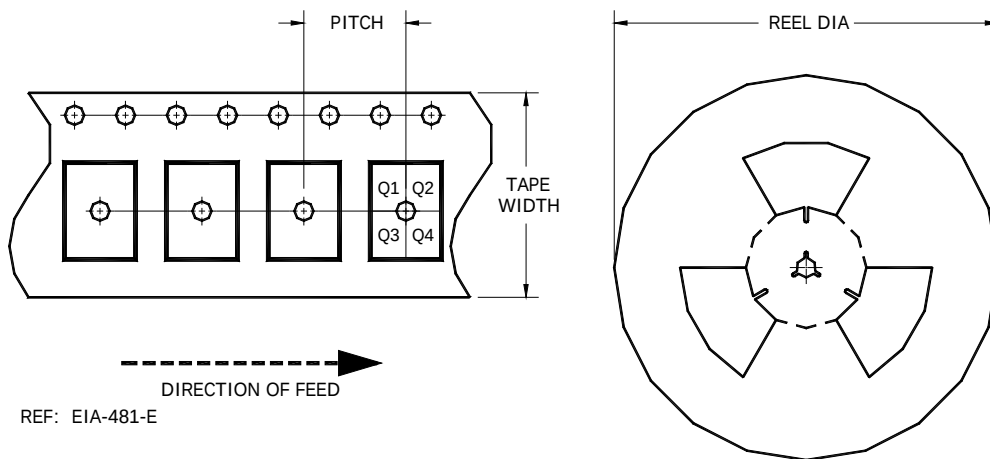
Marking

Line 1 = XXXXX (Lot code)
Dot to denote Pin 1 location

Package Information

Leadframe: C194
Plating: NiPdAu

Tape and Reel Dimensions



Part Number	Size	Pitch	Tape Width	Pin Orient.	Reel Dia.	Count
IM821B	5.0 x 3.2	8.0 ± 0.1	12.3 max	Q1	180 Dia	1000
					330 Dia	3000
IM821C	3.2 x 2.5	4.0 ± 0.1	8.3 max	Q1	180 Dia	3000
IM821D	2.5 x 2.0	4.0 ± 0.1	8.3 max	Q1	180 Dia	3000
IM821E	2.0 x 1.6	4.0 ± 0.1	8.3 max	Q1	180 Dia	3000

Notes:

- All dimensions are in mm.
- Do not scale drawings.

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